



SOT477B

plastic single-ended multi-chip package; magnetized ferrite magnet (8 x 8 x 4.5 mm); 4 interconnections; 3 in-line leads

8 February 2016

Package information

1. Package summary

Terminal position code	S (single)
Package type descriptive code	SIP3
Package type industry code	SIP3
Package style descriptive code	SIP (single in-line package)
Package style suffix code	NA (not applicable)
Package body material type	P (plastic)
Mounting method type	T (through-hole mount)
Issue date	31-8-2000

Table 1. Package summary

Symbol	Parameter	Min	Typ	Nom	Max	Unit
D	package length	12.75	-	13	13.25	mm
E	package width	5.5	-	5.6	5.7	mm
A ₂	package height	5.7	-	6.4	6.4	mm
n ₂	actual quantity of termination	-	-	3	-	

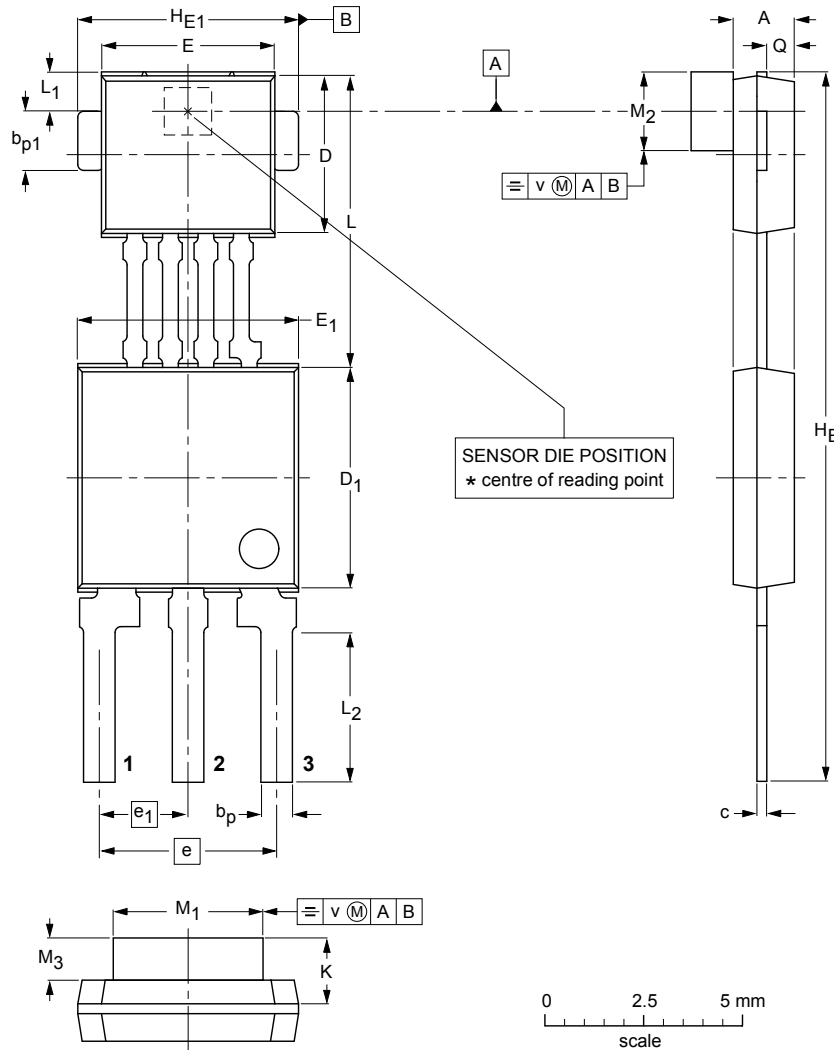


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2. Package outline

Plastic single-ended multi-chip package;
magnetized ferrite magnet (3.8 x 2 x 0.8 mm); 4 interconnections; 3 in-line leads

SOT477A



DIMENSIONS (mm are the original dimensions)

UNIT	A ⁽¹⁾	b _p	b _{p1}	c	D ⁽²⁾	D ₁ ⁽²⁾	E ⁽²⁾	E ₁ ⁽²⁾	e	e ₁	H _E	H _{E1}	K _{max.}	L	L ₁	L ₂	M ₁	M ₂	M ₃ ⁽¹⁾	Q	v
mm	1.7 1.4	0.8 0.7	1.57 1.47	0.3 0.24	4.1 3.9	5.7 5.5	4.5 4.3	5.7 5.5	4.6 4.4	2.35 2.15	18.2 17.8	5.6 5.5	1.67	7.55 7.25	1.2 0.9	3.9 3.5	3.9 3.7	2.1 1.9	0.9 0.75	0.75 0.65	0.25

Notes

1. Glue thickness not included.
2. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT477A						00-08-31

Fig. 1. Package outline SIP3 (SOT477B)

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3. Legal information

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